

音询"HAT2203C"供应简 HAT2203C

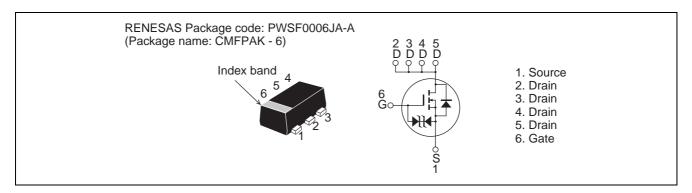
Silicon N Channel MOS FET Power Switching

REJ03G0447-0400 Rev.4.00 May 19.2005

Features

- Low on-resistance $R_{DS(on)} = 69 \ m\Omega \ typ. (at \ V_{GS} = 4.5 \ V)$
- Low drive current
- High density mounting
- 2.5 V gate drive device

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to Source voltage	V _{DSS}	20	V
Gate to Source voltage	V_{GSS}	±12	V
Drain current	I _D	2	А
Drain peak current	I _{D (pulse)} Note1	8	А
Body - Drain diode reverse Drain current	I _{DR}	2	А
Channel dissipation	Pch Note2	830	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. When using the glass epoxy board (FR4 40 x 40 x 1.6mm)

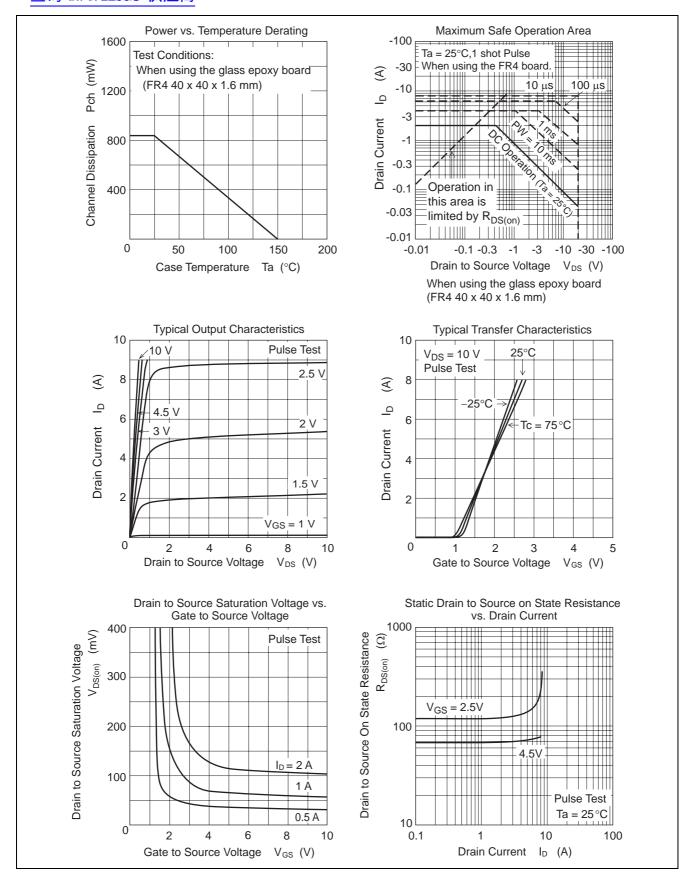
Electrical Chacacteristics

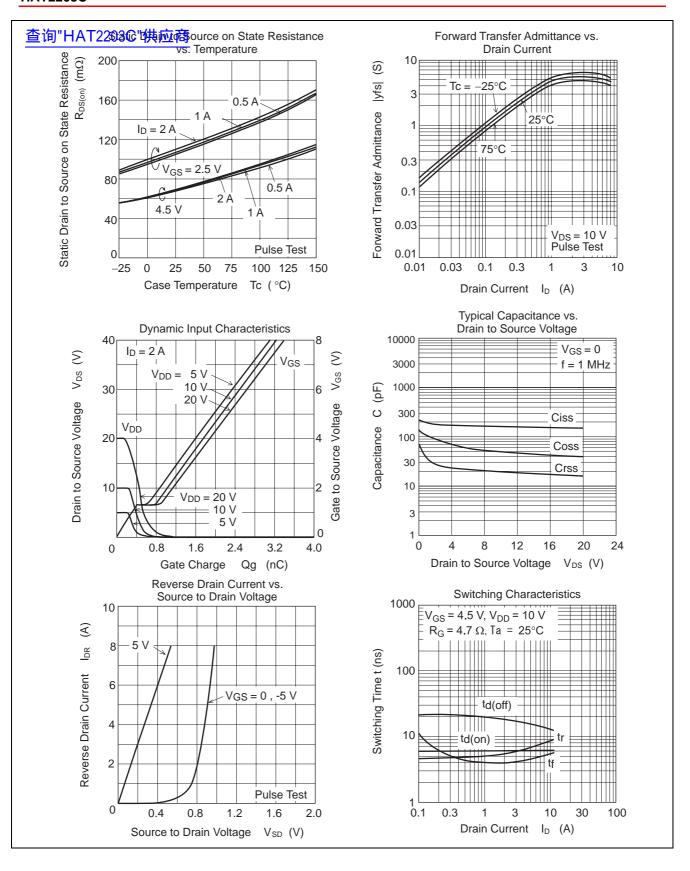
 $(Ta = 25^{\circ}C)$

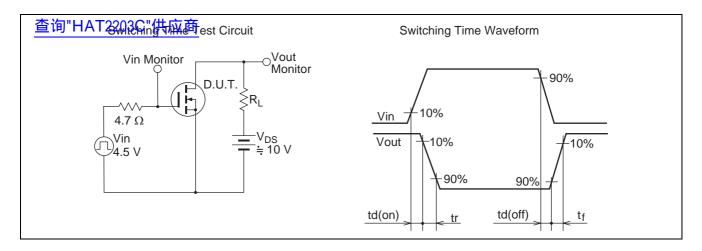
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to Source breakdown voltage	$V_{(BR)DSS}$	20	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to Source breakdown voltage	$V_{(BR)GSS}$	±12				$I_G = \pm 10 \ \mu A, \ V_{DS} = 0$
Gate to Source leak current	I _{GSS}	-	_	±10	μΑ	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$
Drain to Source leak current	I _{DSS}		_	1	μΑ	$V_{DS} = 20 \text{ V}, V_{GS} = 0$
Gate to Source cutoff voltage	$V_{GS(off)}$	0.4	_	1.4	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Drain to Source on state resistance	R _{DS(on)}	_	69	90	mΩ	$I_D = 1 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note3}}$
	R _{DS(on)}	_	107	150	mΩ	$I_D = 1 \text{ A}, V_{GS} = 2.5 \text{ V}^{\text{Note3}}$
Forward transfer admittance	yfs	3	4.5	_	S	$I_D = 1 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note3}}$
Input capacitance	Ciss	_	165	_	pF	V _{DS} = 10 V
Output capacitance	Coss	_	50	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	20	_	pF	f = 1 MHz
Turn - on delay time	t _{d(on)}	_	6	_	ns	I _D = 1 A
Rise time	t _r	_	5	_	ns	V _{GS} = 10 V
Turn - off delay time	$t_{d(off)}$	_	20	_	ns	$R_L = 10 \Omega$
Fall time	t _f	_	4	_	ns	$Rg = 4.7 \Omega$
Total Gate charge	Qg	_	1.8	_	nC	V _{DD} = 10 V
Gate to Source charge	Qgs	_	0.4	_	nC	$V_{GS} = 4.5 \text{ V}$
Gate to Drain charge	Qgd	_	0.4	_	nC	$I_D = 2 A$
Body - Drain diode forward voltage	V_{DF}	_	0.8	1.1	V	$I_F = 2 A$, $V_{GS} = 0$ Note3

Notes: 3. Pulse test

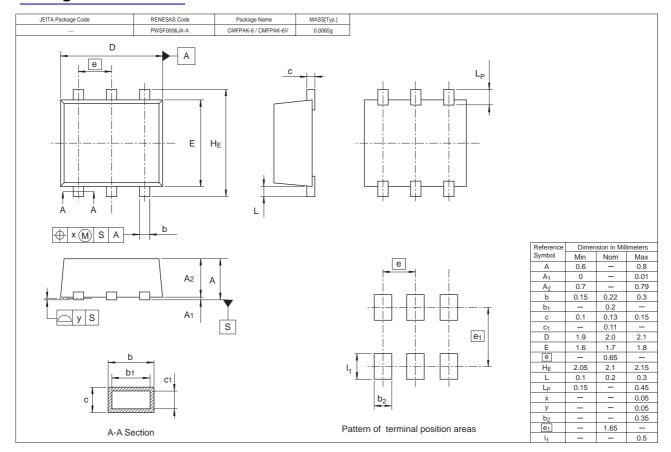
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Package Dimenstons商



Ordering Information

Part Name	Quantity	Shipping Container
HAT2203C-EL-E	3000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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